ZR800 Process Oxygen Analysers



ZR810 Bench/Panel Mount 190H x 237W x 410D (mm) 7.9 kg

15.5kg **Technical Specifications**



ZR820

IP66/NEMA 4X

Wall Mount/Weatherproof

460H x 380W x 160D (mm)

Total

Operating Conditions

	Operating Conditions				
	Sample Inlet Pressure	0.25 to 4 Barg		A	
	Sample Flow Rate	Approximately 150cc/min			
	Sample Temperature	-5 to 50°C			
	Ambient Temperature	-5 to 50°C			
	Sample Humidity	0-99% non-condensing			
	Sample Connections	1/8" OD compression fittin	g		
	Communications	USB/RS232/RS485			
	Unsuitable Gases	Carbon Monoxide, NO2, H	gases, Hydrocarbons, Combustil lalogens, Halogenated Hydrocarb unds, Lead containing compound	oons,	
			use with gases containing low pr es, hydrogen and carbon monoxi		
	Power Requirements				
	Power Supply	90-260 VAC, 50/60 Hz, 80 24 VDC version option.) VA,		
	Display Type	4 digit high visibility LED			
	Options				
	High/Low Alarms	2 Volt free changeover co	2 Volt free changeover contacts. Rated 240VAC / 5A		
	Analogue Outputs Scaleable 4-20mA, 0-20mA, 0-10V, 0-100mV, all isolated, optional for one channel or three		optional for one		
	Autocalibrate	Provision for remote calibi	Provision for remote calibrate start and autocal in progress		
	Sample Stream Options		Bypass flowmeter, Sample pump, Flow alarm, Stainless steel sample system in place of brass/copper.		
	Nitrosave	O ₂ measurement and con	trol system ZR8500		
17 Thame Park Business Centre, Wenman Road,2401JohnsJohnsThame, Oxfordshire OX9 3XAU.S.ATel: +44 (0)1844 216838Tel: +Fax: +44 (0)1844 217220Fax: +E-mail: sales.uk@systechillinois.comE-mailwww.systechillinois.comwww.		Illinois Instruments, Inc (U.S) 2401 Hiller Ridge Road Johnsburg, Illinois 60051 U.S.A Tel: +1 815 344 6212 Fax: +1 815 344 6332 E-mail: sales.usa@systechillinois.com www.systechillinois.com	www.systechillinois.com	Systech Illinois (China) Room 1107-1108 Forte Building No. 910 Quyang Rd, Hongkou disi Shanghai, China 200437 Tel: +86 21 65533022 Fax: +86 21 65539651 Email: info@systechillinois.cn www.systechillinois.cn	

Systech Illinois reserve the right to change specifications without notice. 10/2018

ZR830

Rack Mount 4U - 19 inch Houses 1 or 2 Analysers 178H x 484W x 410D (mm) 9.7kg (single unit)

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Glove Boxes tron Beam 🔳 R & Is
Fermentation tron Beam 🔳 R & I olled Environments , Hongkou district Vessel Blanketing mbustion Analysing Deficiency Ultraviole Purity Gas Production

amics Complete ZR800 Process Oxygen Analysers

operating conditions.



Features & Benefits

- Non depleting, maintenance free oxygen sensor
- Ambient air or traceable gas calib
- Microprocessor controlled function
- Extremely fast response
- Sturdy, reliable construction with mounting options





The ZR800 Oxygen Analysers offer unsurpassed accuracy, reliability and flexibility under the most demanding on-line

	Large, autoranging LED display
	Unaffected by vibration or position
oration	Specific to oxygen
ns	 New hydrocarbon tolerant version for ultra high purity analysis
three	24VDC version

Unmatched Speed in High Performance On-Line Oxygen Analysis

Applications

Electronics

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Solder Powder Production Semiconductor Furnaces Gas Quality

Metals

Heat Treating / Annealing **Steel Production** Pure Metal Production

Pharmaceutical

Inert Packaging Fermentation Vessel Blanketing

Process

Ceramics

Contact Lens Manufacturing Food Packaging **Glass/Fibre Optics** Inert Gas Welding Lamp Manufacturing Solar Cell Manufacturing

General

Gas Production Controlled Environments Glove Boxes Oxygen Deficiency Research & Development

Unmatched Performance

Fast, Accurate, Reliable, Flexible, These characteristics are found in Systech's process oxygen analysers. The ZR800 Series Oxygen Analysers are capable of measuring from 0.1ppm up to 100% oxygen in most industrial gas streams. With a response time and accuracy unparalleled in the industry, the ZR800 has found wide acceptance in the electronics, semiconductor, food processing, and gas manufacturing industries. These microprocessor controlled instruments have user-friendly menu driven software to customise the analyser to meet your requirements. The ZR800 series is specifically designed to provide ultra fast oxygen analysis and performance you can count on.

Cabinetry & Mounting

Three different configurations to match your needs.

- Panel or bench mount
- NEMA 4X / IP66 waterproof and weatherproof
- 19 in. rack mount

Operator Interface / Diagnostics

- User-friendly menu
- Read-only mode available
- Diagnostic capabilities
- Fault alarms

Sampling Systems

- Bypass flowmeter
- Pressure regulator
- Sample pump
- Flow alarm
- Auto Calibration
- Cartridge Filter Kit

Outputs & Alarm Options

For charting, process control, or remote monitoring.

- USB and RS485, standard
- Analogue outputs (one or three channels), optional
- High / low alarms, optional
- Fault alarm, standard

Precision Sensors

All ZR800 Oxygen Analysers utilise precision Zirconia Oxide sensors for accurate detection of oxygen.





ZR830



The relationship between the oxygen concentration of the unknown gas, the oxygen concentration of the reference gas (typically air which is 20.9% oxygen by volume), the temperature, the voltage output, and the cell constant is defined by the Nernst Equation which states:



The oxygen detection cell is a high purity, high density, stabilised zirconia ceramic. The sensor produces a voltage signal relative to the oxygen concentration of the sample gas stream. The cell's logarithmic output is converted and linearised by a high speed microprocessor to provide a direct digital readout on the instrument's LED display.

The conventional zirconium oxide cell consists of a zirconium oxide ceramic tube plated with porous platinum electrodes on its inner and outer surfaces. As the sensor is heated above 600°C, it becomes permeable to oxygen ions (O_2) with vacancies in its crystal lattice structure permitting their mobility. Because of this, the sensor becomes an oxygen ion-conducting electrolyte.

The electrodes provide a catalytic surface for the change in oxygen molecules, O₂, to oxygen ions, and oxygen ions to oxygen molecules. Oxygen molecules on the high concentration reference gas side of the cell gain electrons to become ions which enter the electrolyte. Simultaneously, at the inner electrode, oxygen ions lose electrons and become released from the surface as oxygen molecules.

When the oxygen concentration differs on each side of the sensor, oxygen ions migrate from the high concentration side to the low concentration side. This ion flow creates an electronic imbalance resulting in a DC voltage across the electrodes. This voltage is a function of the sensor temperature and the ratio of oxygen partial pressures (concentrations) on each side of the sensor.

Stabilized ZrO2 electrolyte

Basic Principle of Operation

Zirconia Oxide Sensor Theory





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